

11-07-2005

Form PTO-1595 (Rev. 03/05)  
OMB No. 0651-0027 (exp. 6/30/2005)

U.S. DEPARTMENT OF COMMERCE  
United States Patent and Trademark Office



T

10/31/05

103114815  
PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of conveying party(ies)**  
Tai Cheul Kim and Hyun Jin Kim  
Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
Name: K.I.C.A. Inc.  
Internal Address: \_\_\_\_\_

**3. Nature of conveyance/Execution Date(s):**  
Execution Date(s) October 6, 2005  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other \_\_\_\_\_

Street Address: Pagoda Bldg. 601  
150-1 Nagwon-dong, Jongno-gu  
City: Seoul  
State: \_\_\_\_\_  
Country: Korea Zip: 110-320  
Additional name(s) & address(es) attached?  Yes  No

11/26/05 U.S. PTO  
11/263205



**4. Application or patent number(s):**  This document is being filed together with a new application.  
A. Patent Application No.(s)  
B. Patent No.(s)  
Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**  
Name: Gary D.E. Pierce, PATE PIERCE & BAIRD  
Internal Address: \_\_\_\_\_  
Street Address: 215 South State Street, Ste 550  
City: Salt Lake City  
State: Utah Zip: 84111  
Phone Number: \_\_\_\_\_  
Fax Number: \_\_\_\_\_  
Email Address: \_\_\_\_\_

**6. Total number of applications and patents involved:** 1  
**7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00**  
 Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**8. Payment Information**  
a. Credit Card Last 4 Numbers 1007  
Expiration Date 03/07  
b. Deposit Account Number \_\_\_\_\_  
Authorized User Name \_\_\_\_\_

**9. Signature:** Gary D.E. Pierce Signature October 31, 2005 Date  
Gary D.E. Pierce Name of Person Signing  
Total number of pages including cover sheet, attachments, and documents: 3

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:  
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

11/03/2005 MBIZUNES 00000026 11263205  
04 FC:8021

40.00 DP

PATENT

REEL: 017171 FRAME: 0351

**A S S I G N M E N T**

We the inventors:

Name: KIM, Tai Cheul  
Address: 29 Geumho-dong 1-ga, Seongdong-gu,  
City/State: Seoul 133-800  
Country: Republic of Korea

Name: KIM, Hyun Jin  
Address: Samsung Raemian Apt. 107-1201,  
91-5 Dogok-dong, Gangnam-gu,  
City/State: Seoul 135-537  
Country: Republic of Korea

(For additional inventors, please attach an additional Sheet)  
 Additional Sheet is attached

have invented a method and apparatus entitled:  
"HAIR IRON"

hereinafter called the "invention."

Preferred embodiments of said invention are disclosed in United States patent application Serial No. \_\_\_\_\_, filed on \_\_\_\_\_, and now identified as File No. \_\_\_\_\_ of the law firm of PATE PIERCE & BAIRD, 215 South State Street, Suite 550, Salt Lake City, Utah 84111.

The Assignees, K.I.C.A Inc., a corporation of Republic of Korea having a principal place of business at Pagoda Bldg. 601, 150-1 Nagwon-dong, Jongno-gu, Seoul 110-320, Republic of Korea, and KIM, Hyun Jin, a citizen of Republic of Korea residing at Samsung Raemian Apt. 107-1201, 91-5 Dogok-dong, Gangnam-gu, Seoul 135-537, Republic of Korea, desire to secure the entire right, title and interest in said invention.

In consideration of \$1.00 and other good and valuable consideration paid to us by the Assignees, the receipt and sufficiency of which we hereby acknowledge, WE HEREBY ASSIGN TO THE ASSIGNEES:

The entire right, title and interest in said invention, in the above-identified United States provisional patent application and in all divisions, continuations and continuations-in-part of said application, all later filed applications for claiming priority to this provisional application, all reissues or extensions of Letters Patent or Patents granted thereon, and in all corresponding applications filed in countries foreign to the United States, and in all patents issuing thereon in the United States and foreign countries.

The right to file foreign patent applications on said invention in its own name, wherever such right may be legally exercised, including the right to claim the benefits of the International Convention for such applications.

We hereby authorize and request the United States Commissioner of Patents and Trademarks, and such Patent Office officials in foreign countries as are duly authorized by their patent laws to issue patents, to issue any and all patents on said invention to the Assignees as the owners of the entire interest, for the sole use and benefit of the said Assignees, its successors, assigns and legal representatives.


We hereby agree, without further consideration and without expense to us, to sign all lawful papers and to perform all other lawful acts which the Assignees may request of us to make this Assignment fully effective, including, by way of example but not of limitation, the following:

Prompt execution of all original, divisional, substitute, reissue, and other United States and foreign patent applications on said invention, and all lawful documents requested by the Assignees to further the prosecution of any of such patent applications.

Cooperation to the best of our ability in the execution of all lawful documents, the production of evidence, nullification, reissue, extension, or infringement proceedings involving said invention.

This assignment and agreement shall be binding upon our heirs and legal representatives.

Signed at Seoul, Republic of Korea, this 6<sup>th</sup> day of October 2005.



\_\_\_\_\_  
Inventor: KIM, Tai Cheul  
Address: 29 Geumho-dong 1-ga, Seongdong-gu,  
Seoul 133-800, Republic of Korea



\_\_\_\_\_  
Inventor: KIM, Hyun Jin  
Address: Samsung Raemian Apt. 107-1201,  
91-5 Dogok-dong, Gangnam-gu, Seoul 135-537,  
Republic of Korea